



Dimensions

Footprint	6032
L	6mm +/-0.3mm
W	3.2mm +/-0.3mm
H	2.5mm +/-0.3mm
S	1.3mm +/-0.3mm
F	2.2mm +/-0.1mm
K	1.8mm TYP

Packaging Specifications

Packaging	T&R, 330mm
Packaging Quantity	3000

General Information

Dielectric	MnO ₂ Tantalum
Style	SMD Chip
Description	SMD, Molded, High Temperature
Features	High Temperature
RoHS	Yes
Termination	Gold
AEC-Q200	No
Notes	Old Part Number [Obsolete] Was B45198P3226M306.

Specifications

Capacitance	22 uF
Capacitance Tolerance	20%
Voltage DC	16 VDC (85C), 12.75 VDC (125C), 10.72 VDC (150C)
Temperature Range	-55/+150°C
Rated Temperature	85°C
Dissipation Factor	4.5%
Failure Rate	N/A
ESR	1 Ohms (100kHz)
Leakage Current	3.6 uA